



## IBIS in Applications

- Modeling Complex IO with IBIS

IBIS-JEITA Joint Meeting  
March 24, 2005, Tokyo, Japan  
Lance Wang

1 CADENCE DESIGN SYSTEMS, INC.



## Outlines

- Device Models in EDA Tools
- New Challenges and New Studies
- An Applicable Solution - Macromodeling
- An Industrial Macromodeling Example

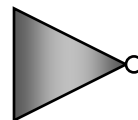
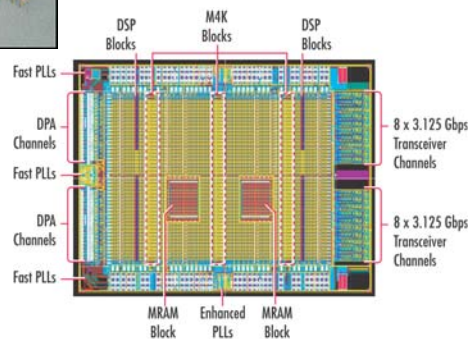
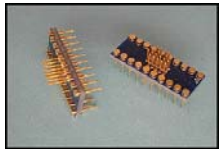
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## Outlines

- Device Models in EDA Tools
  - Transistor Level Models
  - Behavioral Models
  - How EDA tools use Behavioral Models
- New Challenges and New Data
- An Applicable Solution – Macromodeling
- An Industrial Macromodeling Example

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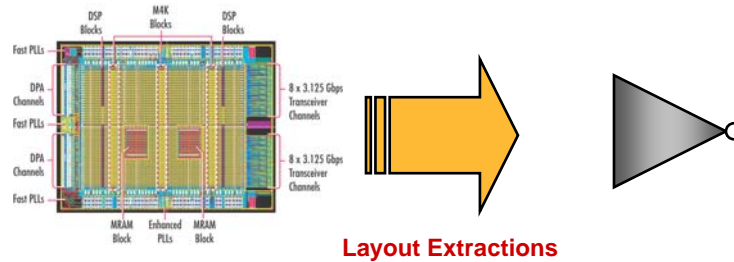
## Device Models



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## Spice Transistor Level Models

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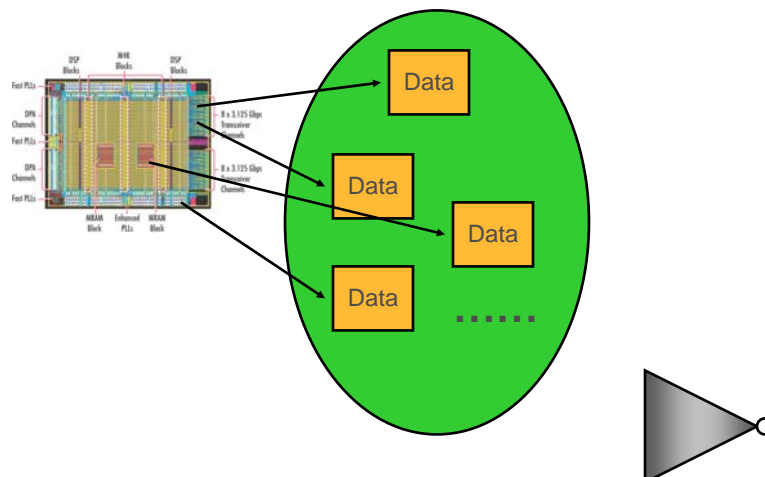


- Very Complicated
- A lots of unusable stuff
- Too slow in the simulations

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## Behavioral Models

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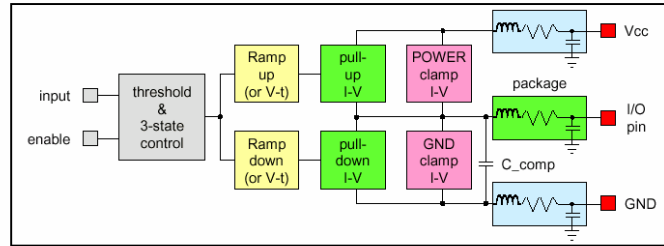


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## Behavioral Model



### IBIS model



Block diagram of CMOS buffer

#### A basic IBIS model consists of:

- four I-V curves: - pullup & POWER clamp
- pulldown & GND clamp
- two ramps: -  $dV/dt_{rise}$
- $dV/dt_{fall}$
- die capacitance: -  $C_{comp}$
- packaging: - RLC values

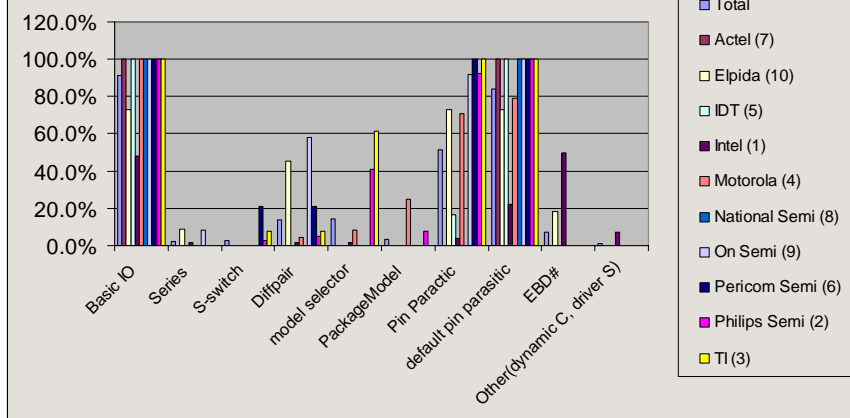
**for each buffer on a chip**

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## IBIS Model Vendors



Top10 IBIS Model Vendors on Web



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## IBIS in EDA Tools



- Major EDA Simulators are supporting IBIS now

- Cadence

- Mentor

- Synopsys

- Laker

- Agilent

SPICE Simulators are taking  
IBIS now !!!  
And many, many more .....

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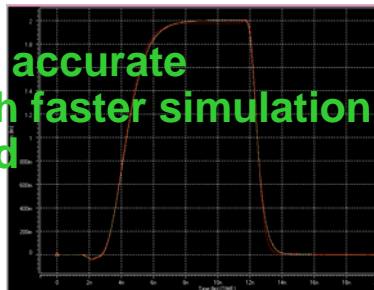
## IBIS in EDA Tools



- Behavioral data in Spice simulators

$$I(\text{pad}) = I_{pd}(V(\text{pad}) - V(\text{gnd})) * W_d(t) + I_{cd}(V(\text{pad}) - V(\text{gnd\_c}))$$
$$+ I_{pu}(V(\text{pad}) - V(\text{pwr})) * W_u(t) + I_{cu}(V(\text{pad}) - V(\text{pwr\_c}))$$

- Results are accurate
- Much, much faster simulation time
- IP Protected



HSpice Transistor Model vs. IBIS Model

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## Support Advance IBIS Features



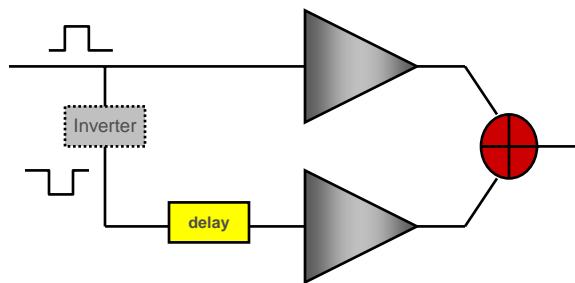
- Driver Schedule
- Series / Series Switch (FET)
- Submodel (Dynamic Clamps, Bus Hold ...)
- Differential Pair
- EBD (Board Models)
- ICM (Interconnect Models)
- More .....

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## IBIS Implementation - Driver Schedule



[Driver Schedule]				
Model_name	Rise_on_dly	Rise_off_dly	Fall_on_dly	Fall_off_dly
driver1	0.0ns	NA	0.0ns	NA
driver2	NA	0.666ns	NA	0.666ns

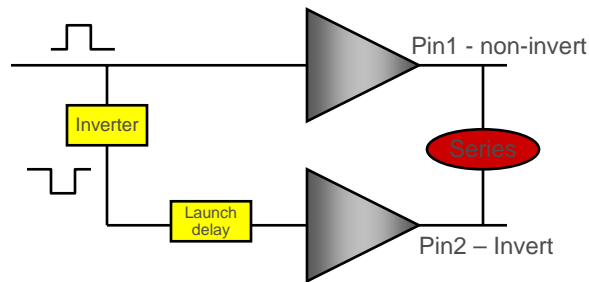


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## IBIS Implementation - Differential Pair Driver



[Diff Pin]	inv_pin	vdiff	tdelay .....
1	2	0	1ns
[Series Pin Mapping]	pin_2	model_name .....	
1	2	Series1	



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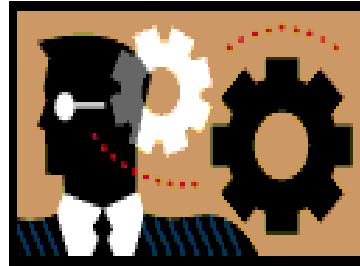
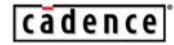
## Outlines



- Device Models in EDA Tools
- New Challenges and New Data
  - Complex-IO Devices
  - New Data from Survey
- An Applicable Solution – Macromodeling
- An Industrial Macromodeling Example

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## Then ..... New Challenges

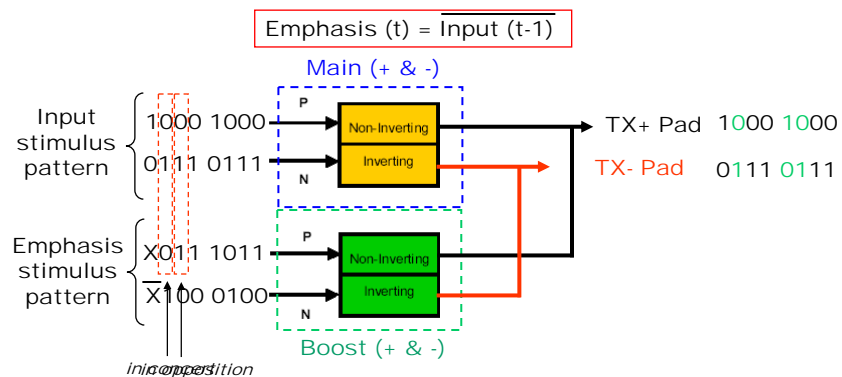


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## Complex-IO Devices



### Pre-emphasis/De-emphasis



Picture from Michael Mirmak's presentation in DesignCon East IBIS Summit 2004

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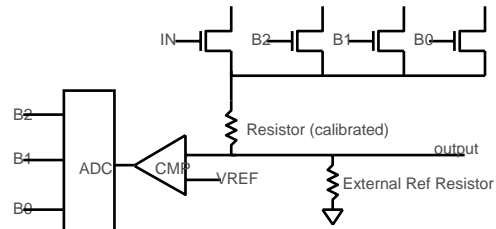
## Complex-IO Devices



### Self calibrating driver

(Calibrating Output Impedance only)

(For DDR2, when controller in a read cycle, the receiver is terminate )  
(50 ohms. The resistor also requires to calibrate at run-time)



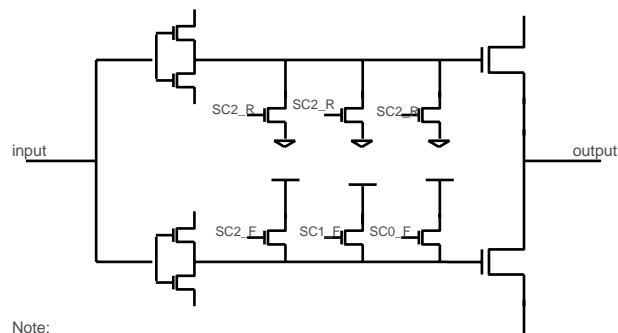
Note:  
1) PMOS side is not being shown here.

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## Complex-IO Devices



### Driver with Slew Rate Control



Note:  
1) For simplicity, Nmos and Pmos are used interchangeable.  
2) Independent slew control for Rise and Fall.

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## Complex-IO Devices



And More to Come ... ..

*As Always for Technologies!!!*

Where is IBIS?

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## The Original “Box”



- 1<sup>st</sup> PCI Chipset  
(33 MHz)

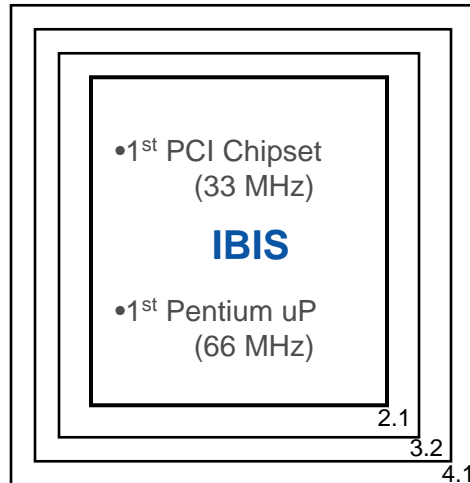
**IBIS**

- 1<sup>st</sup> Pentium uP  
(66 MHz)

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...and the “Box” did grow

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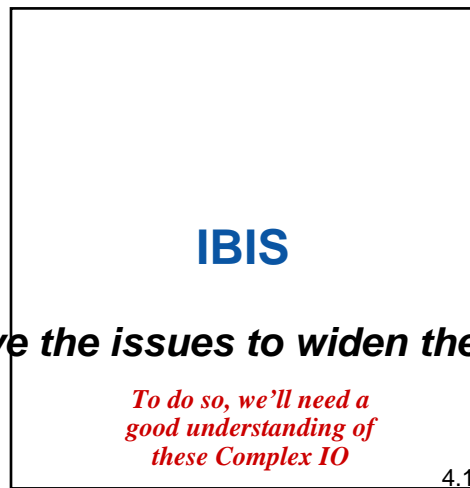


*An increasing amount of Complex IO models are missing the box*

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Our Mission

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## The Current Situation

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*What is the format of most  
of the red dots today?*

4.1

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## 11 Interviews During December 2004

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- All are involved with Complex IO
  - Majority were not CDS users
- Good re-introduction to the issues
- The issues are many
  - and the solutions weren't clear
- Will use this data to propose solutions
- Most want "industry standard solution"
  - but don't know how to get there
- So who will lead?

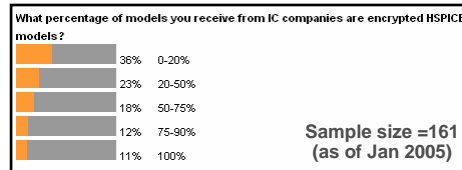


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## High-Speed PCB Web Surveys

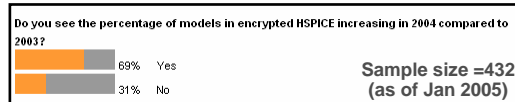


- 64% say that more than 20% of the models they receive are Hspice



<http://www.pcbhighspeed.com/discuss/user/non-frames/surveyresults.asp?surveyid=62>

- 69% say that this percentage increased in 2004 over 2003



<http://www.pcbhighspeed.com/discuss/user/non-frames/surveyresults.asp?surveyid=63>

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## HSpice Related Interview Questions



- “Do you want to see [External Model] HSpice?” - all “yes”
  - Half qualified this as a non-optimal short-term solution

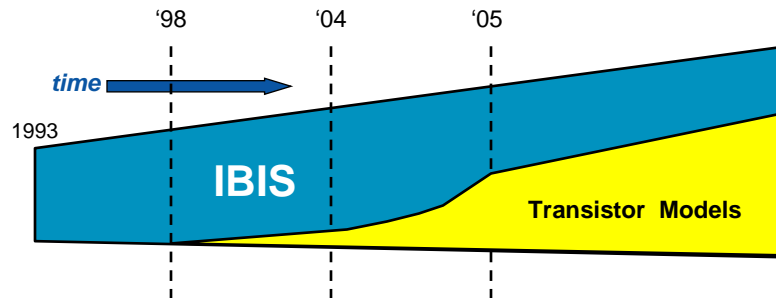
*This is actually already happening*

- “Do you see HSpice as a long-term solution?” - all “no”
  - Unanimous reason: “it’s too slow”
- As such, also unanimous in need to return to behavioral

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## What has Happened

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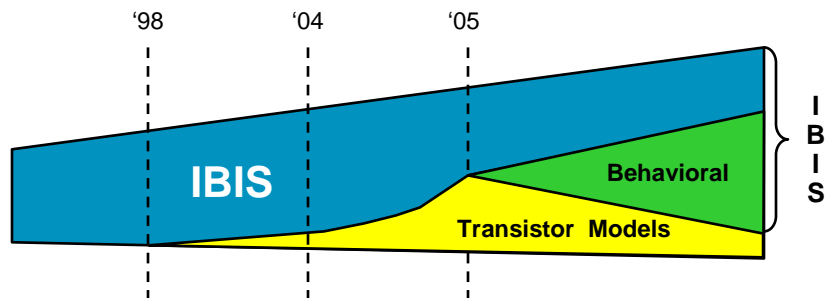


- IBIS enjoyed 5 years as THE digital IO model format
- Higher frequencies brought new issues and more skeptics
- Gigabit serial links brought rapid transistor model increase in 2004

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## What Must Happen

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- Enable faster behavioral solutions

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## Features of Behavioral Solution



1. Fast
2. Protects IP
3. Template based
4. Works in many tools
5. Have links to IC design

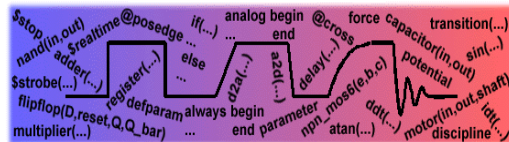
*What behavioral options exist?*

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## AMS Models – the Positives



- Most interviewed at this point are unfamiliar with AMS
  - When asked if they think AMS can be a good solution:  
3 said “yes”, 3 were hopeful, and 4 were unsure, 1 said no
- The experts list the following positives
  - Standards with documented specs
  - Mathematical freedom
  - Conditionals
  - File IO
  - Flexible language



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## AMS Models – Issues to Solve



- Unfamiliar in SI world, learning curve exists
  - Must seed with templates / training
- Spec nuances/implementations (as with IBIS)
- Not naturally occurring in IO design
  - This is why transistor-level models get used
- IP protection
  - 3 would encrypt, 2 might, 4 are unsure, 2 would not



## Any other solutions?

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## Outlines



- Device Models in EDA Tools
- New Challenges and New Data
- An Applicable Solution – Macromodeling
  - What is Macromodeling and Why
  - Our Experiences
- An Industrial Macromodeling Example

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## What is MacroModeling and Why?

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M  
M  
M

**KEY Conclusions**

Equation-based macromodeling of LVDS drivers

- ❖ Flexible methodology
  - no specific assumption on device internal structure (preserve IP)
  - handle drivers with enhanced features (e.g., control ckts)
- ❖ Accurate and efficient macromodel (5-10x speed-up)
- ❖ Straightforward SPICE, VHDL-AMS implementations
- ❖ Ready available also for EDA SI tools via the IBIS multilingual extension

In progress: modeling of LVDS drivers with pre-emphasis

Methodology only

AMS needs MacroModeling Methodology too !!!

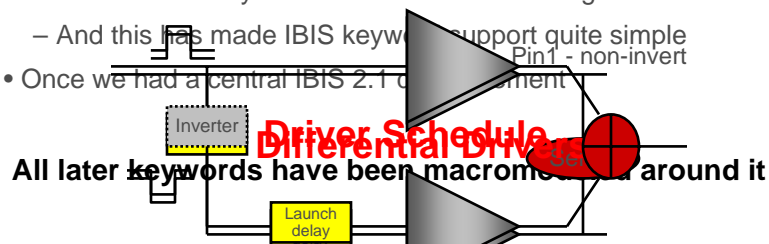
SPI 2004
SPI 2004
17
EMC group

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## What Our Experience has Shown

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- Spice Macromodeling is everywhere
- Cadence has always had SPICE macromodeling
  - And this has made IBIS keyword support quite simple
- Once we had a central IBIS 2.1 driver element



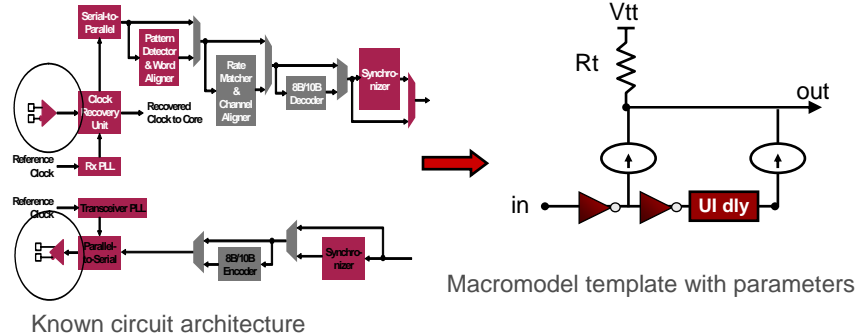
All later keywords have been macromodeled around it

- In other words, basic SPICE around a B driver element has handled everything IBIS has added for the last 10+ years
- Template is another KEY for Complex-IO Modeling

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## Macromodel from architecture templates

- Most modern devices are based on known DSP circuit architectures



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## Behavioral SPICE Solutions

- 2.5 Gbps PCIe SerDes Chipset
  - [http://www.cadence.com/company/newsroom/press\\_releases/pr.aspx?xml=090804\\_intel](http://www.cadence.com/company/newsroom/press_releases/pr.aspx?xml=090804_intel)
- 1.5 Gbps S-ATA SerDes
  - <http://www.designcon.com/conference/7443.html>
- Differential pass-thru receiver
  - <http://www.cadence.com/pub/ols/whitepapers/jan00/telian.zip>
- Adjustable FPGA SerDes
  - [http://www.altera.com/corporate/news\\_room/releases/releases\\_archive/2004/products/nr-cadence\\_design\\_kit.html](http://www.altera.com/corporate/news_room/releases/releases_archive/2004/products/nr-cadence_design_kit.html)
- Front-side bus driver, impedance control, SSN, & gate choke effect
  - [http://www.cadence.com/company/newsroom/press\\_releases/11\\_16\\_98\\_SQ\\_Intel\\_Merced\\_Proc\\_ssor.doc](http://www.cadence.com/company/newsroom/press_releases/11_16_98_SQ_Intel_Merced_Proc_ssor.doc)
- Others under NDA, mostly higher speed SerDes

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*The technique has been used for many "beyond IBIS" Complex IO models*

## SPICE Macromodeling



- Many tools and users have experience with it
- With template help, model makers are succeeding
- Academia is quite engaged in macromodeling research

- [http://domino.research.ibm.com/acas/w3www\\_acas.nsf/images/proposals\\_04.05/\\$FILE/madhavan.pdf](http://domino.research.ibm.com/acas/w3www_acas.nsf/images/proposals_04.05/$FILE/madhavan.pdf)
- [http://domino.research.ibm.com/acas/w3www\\_acas.nsf/images/projects\\_03.04/\\$FILE/canavero.pdf](http://domino.research.ibm.com/acas/w3www_acas.nsf/images/projects_03.04/$FILE/canavero.pdf)
- [http://www.spi.uni-hannover.de/2004/presentations/spi04\\_s08\\_p02\\_Stievano.pdf](http://www.spi.uni-hannover.de/2004/presentations/spi04_s08_p02_Stievano.pdf)
- [http://www.ece.ncsu.edu/erl/html2/papers/paulf/2003/paulf\\_2003\\_10\\_varma.pdf](http://www.ece.ncsu.edu/erl/html2/papers/paulf/2003/paulf_2003_10_varma.pdf) ... etc.

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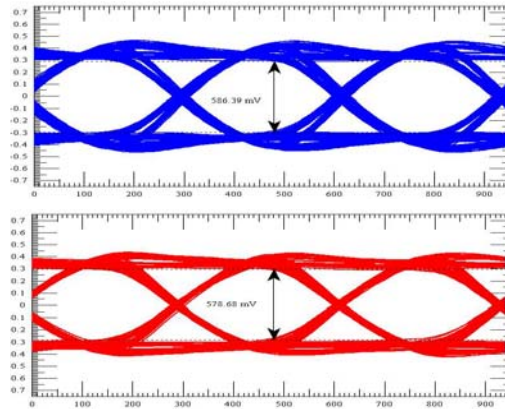
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## Industry example- Altera Stratix GX



“Altera successfully adapted the MacroModel templates to produce fast and accurate models of our multi-gigabit transceivers. Not only did the resulting model correlate well, it also simulates between 20 to 400 times faster than its transistor-level counterpart. And the model can be easily adjusted to match the behaviors of actual silicon measured in the lab.”

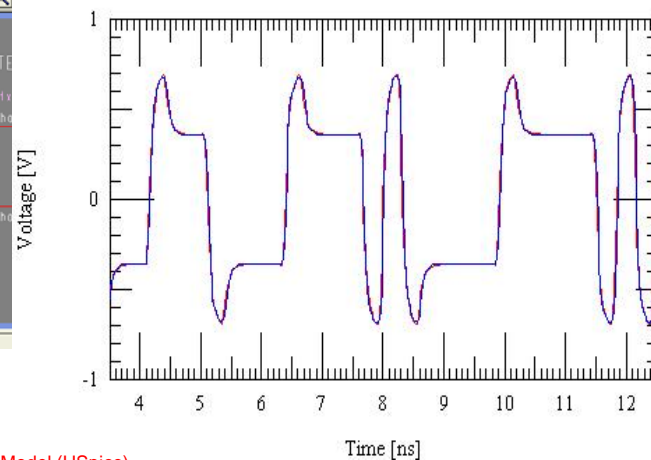
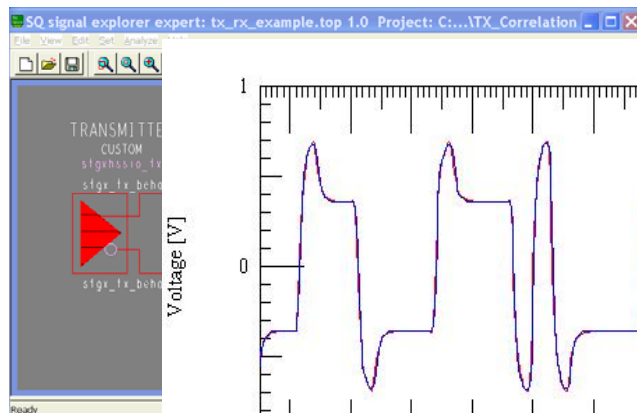


Correlation: MacroModel vs TransistorModel

“Overall, the templates were simple to work with and very valuable amidst the challenges of multi-gigahertz design.”

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## Correlation - Altera Stratix GX



- Transistor Level Model (HSpice)
- Spice Macromodel (Cadence DML)

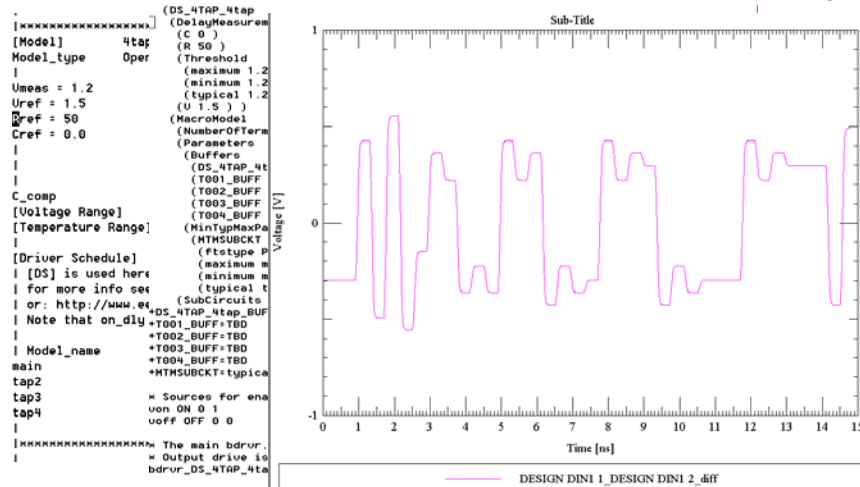
Transmitter output at factor=5

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And, the latest news



- Driver Schedule in IBIS for 4 tap pre-emphasis buffer is working



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Thank You

謝謝

